

1. Features

- Typical 1dB bandwidth of 18.5 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

RoHS Compliant

Tested by SGS Testing Korea

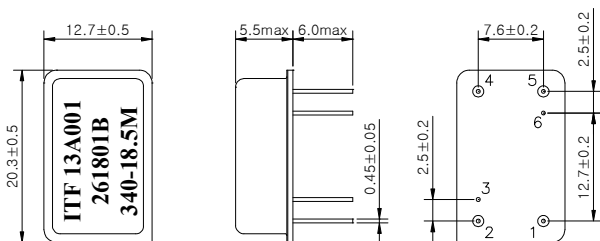
2. Electrical Specifications

Source and Load Impedance = 50Ω

Room Temperature : +25°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	340.0	-
Insertion Loss	dB	-	28.0	30.0
1dB Bandwidth	MHz	18.4	18.55	-
3dB Bandwidth	MHz	-	18.97	-
40dB Bandwidth	MHz	-	20.94	21.1
Amplitude Ripple (Fo±9.0MHz)	dB	-	0.7	-
Group Delay Variation (Fo±9.0MHz)	nsec	-	30	60
Absolute Delay	usec	-	2.14	2.2
Temperature Coefficient of Frequency	ppm/°C	-	-18	-
Relative Attenuation @Edge±5.0MHz	dB	-	-	-
		50	55	-

@Edge : 9.0MHz, Input POWER : + 10dBm

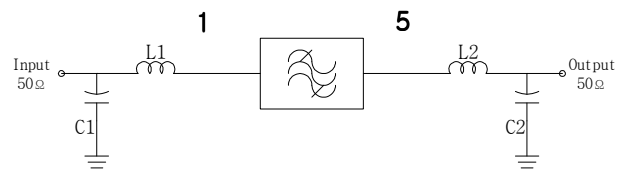
D2012 Package Dimension



Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated
Cap : Cu & Cr Alloy, Ni Plated
Termination : Kovar, Au Plated

Matching Schematic



L1 = 3.9nH , L2 = 4.7nH, C1 = 20pF, C2 = 16pF

Pin Configuration

Pin Configuration			
Input	1	Ground	2,4
Output	5	Others	Ground

3. Typical Performance (at +25°C)

